

English | 简体中文 | 日本語

Search Entire Site

Contact IDT | Investors | Press

About IDT

Products

Applications

Support

myIDT

▶ GO

Document Search | Package Search | Parametric Search | Cross Reference Search | Green & RoHS | Calculators | Thermal Data | Reliability & Quality | Military

You may also like...

Home > Products > > SSTUB32866C > SSTUB32866CHLF

Add to myIDT [?]

SSTUB32866CHLF

Category:

Description:

Generic Part: Market Group: SSTUB32866C

RDIMM

1.8V REG. BUFFER (800 MHZ

Time is money

**Parameters** 

Package	CABGA 96 (BFG96)
Speed	NA
Temperature	С
Voltage	3.3 V
Status	Active
Sample	No
Minimum Order Quantity	270
Factory Order Increment	270

## **Package**

Description	CHIP ARRAY BGA 5.5 X 13.5 MM X 0.8 MM PI
Class	PLASTIC
Moisture Sensitivity Level (MSL)	3
Category	Green
Moisture Exposure Floor Life	168 hrs. @ <30°C/60%RH
Peak Reflow Temprature	260°C
Rebake Conditions	48 hrs.@125°C
Length	13.5
Mark	Н
Width	5.5
Pitch	0.8
Thickness	1.4
Status	Active

## **Distributor Inventory**

No Pricing information is available from our Distributors at this time.

## **Documents**

Туре	Title	Size	Revision Date
Product Change Notice	PCN# : A-0607-02 IDT Penang as Alternate Assembly Facility for ICS CVBGA and FPBGA	100 KB	07/27/2006
	PCN# A-0607-05 Green Mold Compound KMC3580 for BGA	195 KB	08/30/2006
	PCN# : A-0610-02 ASAT China as Alternate Facility for CABGA/CVBGA/FPBGA/TQFP/PQFP	253 KB	10/19/2006